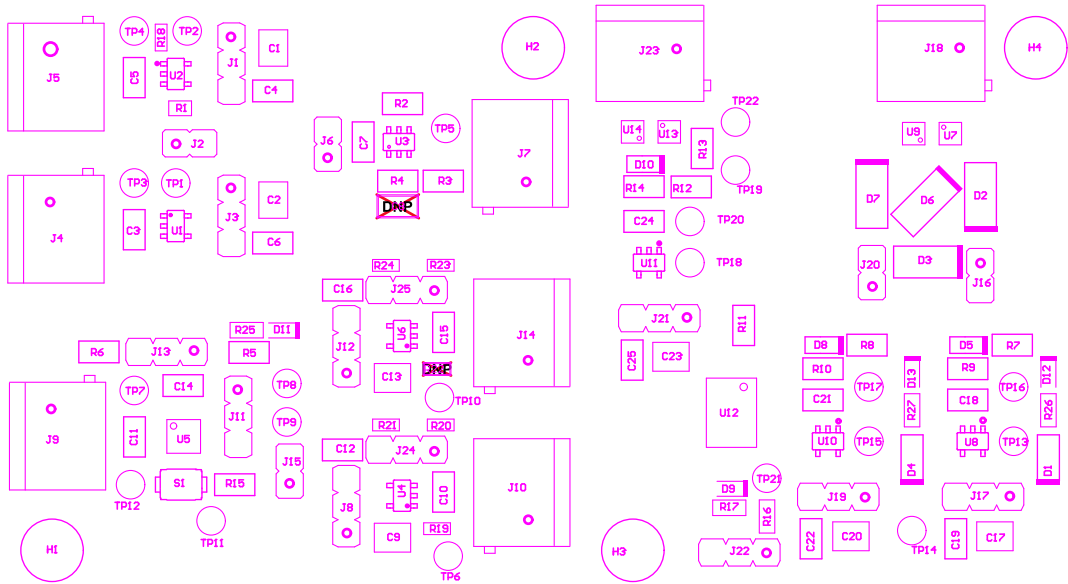


- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
- Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

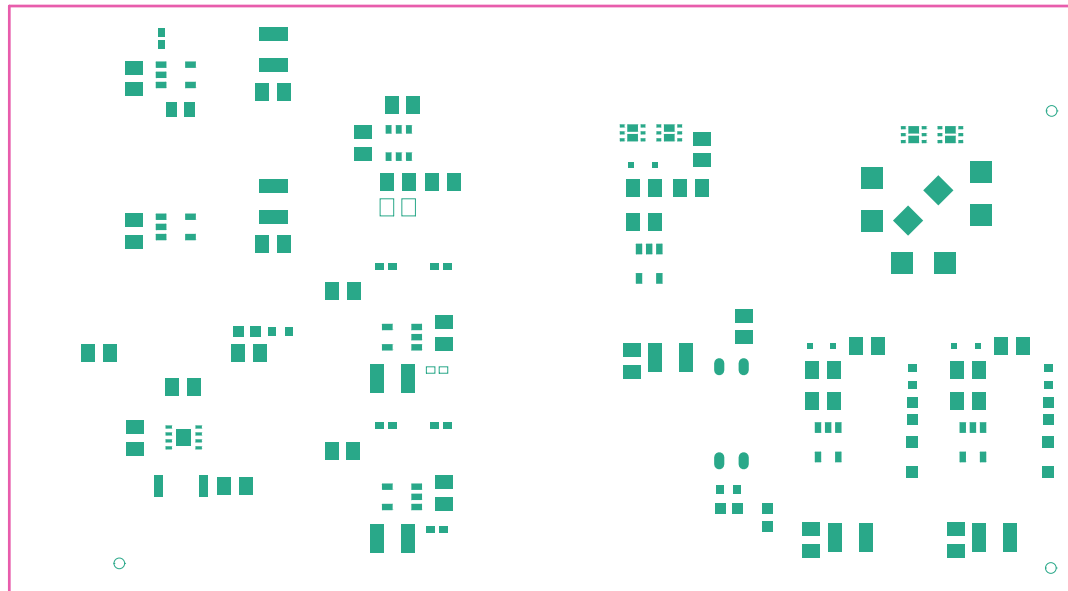


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT:

001

PCB VIEWED FROM TOP SIDE	BOARD #:	TIDA-010041	REV:	E1	SUN REV:	Not In VersionControl
LAYER NAME =	HS Assembly Top					
PLOT NAME =	Top LayerAssembly Drawing		GENERATED :	4/5/2019	11:42:18 AM	TEXAS INSTRUMENTS



Top Paste

PLOT NAME = Bottom Layer Assembly Drawing		GENERATED : 4-25-2018 11:45:18 AM		TEXAS INSTRUMENTS
LAYER NAME = ME Assembly Bottom		TID # 00010		
PCB VIEWED FROM BOTTOM SIDE		BOARD # : TIDA-01004	REV: E1	SUM REV: Not In VersionControl

ASSEMBLY VARIANT:
001
COMPONENTS MARKED 'DNP,' SHOULD NOT BE POPULATED.





Bottom Paste

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